TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (Ultra-High-speed U-MOSIII)

TPCP8103-H

High Efficiency DC-DC Converter Applications Notebook PC Applications Portable Equipment Applications CCFL Inverter Applications

- Small footprint due to a small and thin package
- High speed switching
- Small gate charge: QSW = 6.5 nC (typ.)
- Low drain-source ON-resistance: R_{DS} (ON) = 31 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 10 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -40V)$
- Enhancement mode: $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

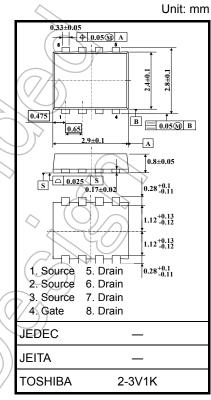
Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V _{DSS} <	-40	/y
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		VDGR	-40	$\langle \mathbf{v} \rangle$
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	ÉD (-4.8	A
	Pulsed (Note 1)		-19.2	
Drain power dissipation (t = 5 s) (Note 2a)		PD	1.68	W
Drain power dissipation $(t = 5 s)$ (Note 2b)		PD <	0.84	W
Single-pulse avalanche energy (Note 3)		EAS	10.7	mJ
Avalanche current		I _{AR}	-4.8	А
Repetitive avalanche energy (Note 4)		EAR	0.09	mJ
Channel temperature		Tch	150	°C
Storage temperature range		T _{stg}	–55 to 150	°C

Note: For Notes 1 to 4, refer to the next page.

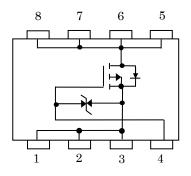
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

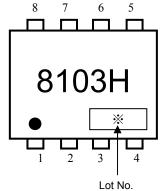


Weight: 0.017 g (typ.)

Circuit Configuration



Marking (Note 5)

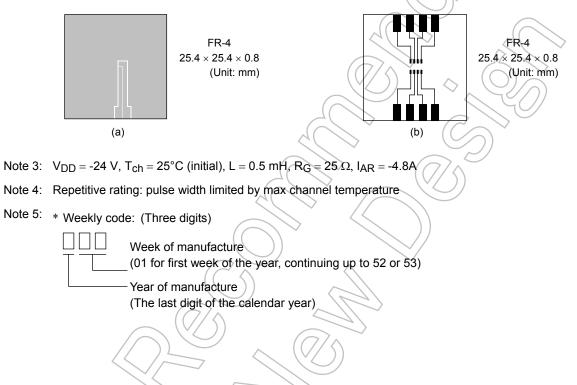


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Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R _{th (ch-a)}	74.4	°C/W
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2b)	R _{th (ch-a)}	148.8	°C/W

- Note 1: The channel temperature should not exceed 150°C during use.
- Note 2: (a) Device mounted on a glass-epoxy board (a)
- (b) Device mounted on a glass-epoxy board (b)



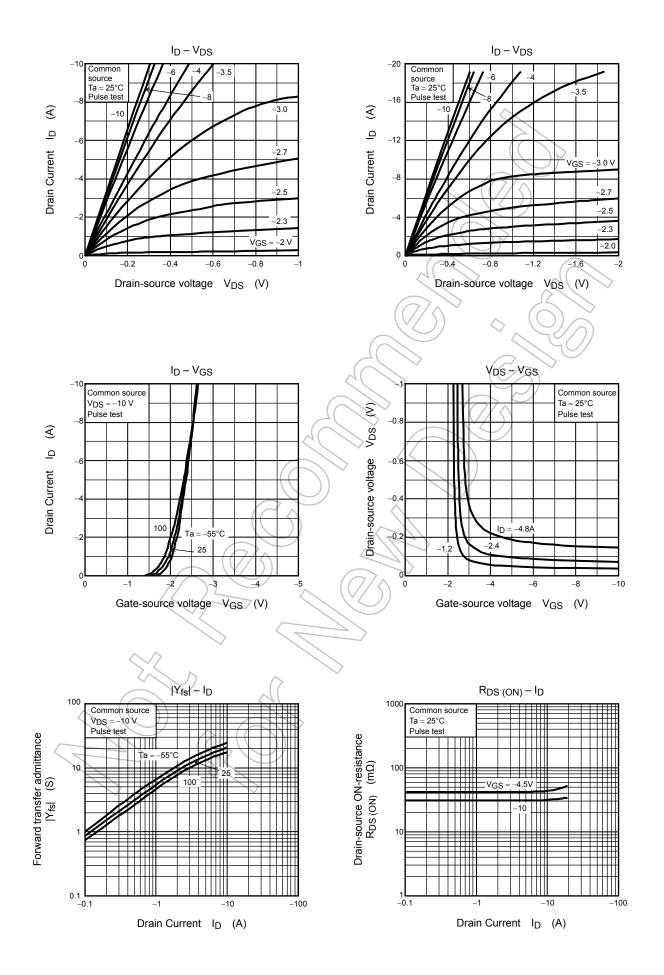
Electrical Characteristics (Ta = 25°C)

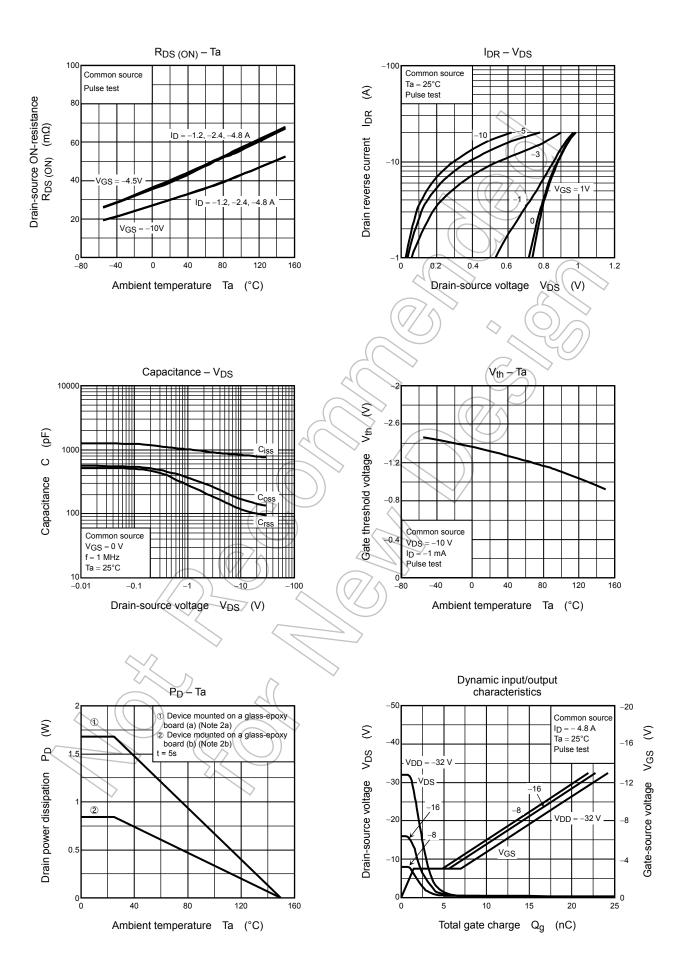
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	_	±10	μA
Drain cutoff curre	ent	I _{DSS}	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	-10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-40	_	_	v
		V (BR) DSX	$I_D = -10$ mA, $V_{GS} = 20$ V	-20	1	_	v
Gate threshold vo	oltage	V _{th}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8)/(-2.0	V
Drain-source ON-resistance		R _{DS (ON)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2.4 \text{ A}$	77	42	54	- mΩ
			$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.4 \text{ A}$	Ĥ	31	40	
Forward transfer	admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.4 \text{ A}$	5	10	_	S
Input capacitance		C _{iss}			800	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	115		pF
Output capacitance		C _{oss}		_	165	\searrow	
Switching time	Rise time	tr			6.5	>_	
	Turn-on time	t _{on}			12.5	_	
	Fall time	t _f	ערייאל אייר איין איין איין איין איין איין איין	$\widehat{\mathcal{A}}$	9		ns
	Turn-off time	toff	Duty $\leq 1\%$; $t_{W} = 10 \ \mu s$) —	37	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx -32 \text{ V}, \text{ V}_{GS} = -10 \text{ V},$ $I_{D} = -4.8 \text{ A}$		19		
		, sig	$V_{DD} \approx -32$ V, $V_{GS} = -5$ V, $I_D = -4.8$ A	_	11	—	nC
Gate-source cha	rge 1	Q _{gs1}		_	1.5	—	
Gate-drain ("Miller") charge		Qgd	V _{DD} ≈ −32 V, V _{GS} = −10 V, I _D = −4.8 A		5.5	_	
Gate switch charge		QSW		_	6.5	_	

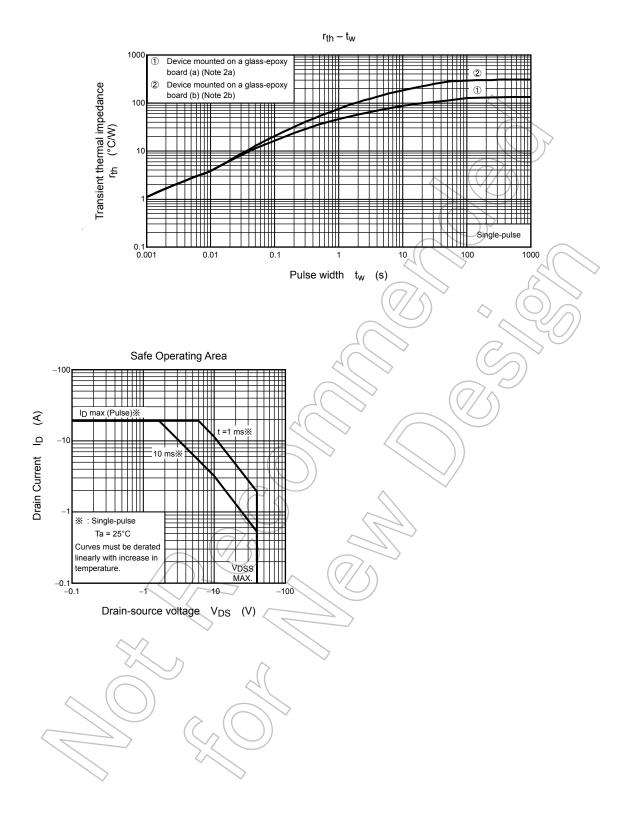
Source-Drain Ratings and Characteristics (Ta = 25° C)

Characteristic	Symbol Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note 1)	I _{DRP} —	—		-19.2	А
Forward voltage (diode)	V_{DSF} $I_{\text{DR}} = -4.8 \text{ A}, V_{\text{GS}} = 0 \text{ V}$	—		1.2	V

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